## APTGT225DU170G

## Dual common source Trench + Field Stop IGBT3 Power Module



$$
\begin{aligned}
& \mathbf{V}_{\mathrm{CES}}=1700 \mathrm{~V} \\
& \mathbf{I}_{\mathrm{C}}=\mathbf{2 2 5 A} @ \mathbf{T c}=80^{\circ} \mathrm{C}
\end{aligned}
$$

## Application

- AC Switches
- Switched Mode Power Supplies
- Uninterruptible Power Supplies


## Features

- Trench + Field Stop IGBT3 Technology
- Low voltage drop
- Low tail current
- Switching frequency up to 20 kHz
- Soft recovery parallel diodes
- Low diode VF
- Low leakage current
- RBSOA and SCSOA rated
- Kelvin emitter for easy drive
- Very low stray inductance
- Symmetrical design
- M5 power connectors
- High level of integration


## Benefits

- Stable temperature behavior
- Very rugged
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Easy paralleling due to positive TC of VCEsat
- Low profile
- RoHS Compliant

Absolute maximum ratings

| Symbol | Parameter |  | Max ratings | Unit |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {CES }}$ | Collector - Emitter Breakdown Voltage |  | 1700 | V |
| $\mathrm{I}_{\mathrm{C}}$ | Continuous Collector Current | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 340 | A |
|  |  | $\mathrm{T}_{\mathrm{C}}=80^{\circ} \mathrm{C}$ | 225 |  |
| $\mathrm{I}_{\text {CM }}$ | Pulsed Collector Current | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 450 |  |
| $\mathrm{V}_{\text {GE }}$ | Gate - Emitter Voltage |  | $\pm 20$ | V |
| $\mathrm{P}_{\mathrm{D}}$ | Maximum Power Dissipation | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 1250 | W |
| RBSOA | Reverse Bias Safe Operating Area | $\mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C}$ | 450A@1600V |  |

FAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

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All ratings @ $\mathbf{T}_{\mathrm{j}}=\mathbf{2 5}{ }^{\circ} \mathrm{C}$ unless otherwise specified
Electrical Characteristics

| Symbol | Characteristic | Test Condit |  | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{I}_{\text {CES }}$ | Zero Gate Voltage Collector Current | $\mathrm{V}_{\mathrm{GE}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{CE}}=1700 \mathrm{~V}$ |  |  |  | 500 | $\mu \mathrm{A}$ |
| $\mathrm{V}_{\mathrm{CE} \text { (sat) }}$ | Collector Emitter Saturation Voltage | $\begin{aligned} & \mathrm{V}_{\mathrm{GE}}=15 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{C}}=225 \mathrm{~A} \end{aligned}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  | 2.0 | 2.4 | V |
|  |  |  | $\mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C}$ |  | 2.4 |  |  |
| $\mathrm{V}_{\mathrm{GE}(\mathrm{th})}$ | Gate Threshold Voltage | $\mathrm{V}_{\mathrm{GE}}=\mathrm{V}_{\mathrm{CE}}, \mathrm{I}_{\mathrm{C}}=4 \mathrm{~mA}$ |  | 5.0 | 5.8 | 6.5 | V |
| $\mathrm{I}_{\text {GES }}$ | Gate - Emitter Leakage Current | $\mathrm{V}_{\mathrm{GE}}=20 \mathrm{~V}, \mathrm{~V}_{\mathrm{CE}}=0 \mathrm{~V}$ |  |  |  | 600 | nA |

## Dynamic Characteristics

| Symbol | Characteristic | Test Conditi |  | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{C}_{\text {ies }}$ | Input Capacitance | $\begin{aligned} & \mathrm{V}_{\mathrm{GE}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CE}}=25 \mathrm{~V} \\ & \mathrm{f}=1 \mathrm{MHz} \end{aligned}$ |  |  | 20 |  | nF |
| $\mathrm{C}_{\text {oes }}$ | Output Capacitance |  |  |  | 0.8 |  |  |
| $\mathrm{C}_{\text {res }}$ | Reverse Transfer Capacitance |  |  |  | 0.66 |  |  |
| $\mathrm{T}_{\mathrm{d} \text { (on) }}$ | Turn-on Delay Time | $\begin{aligned} & \text { Inductive Switching }\left(25^{\circ} \mathrm{C}\right) \\ & \mathrm{V}_{\mathrm{GE}}=15 \mathrm{~V} \\ & \mathrm{~V}_{\text {Bus }}=900 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{C}}=225 \mathrm{~A} \\ & \mathrm{R}_{\mathrm{G}}=3.3 \Omega \\ & \hline \end{aligned}$ |  |  | 370 |  | ns |
| $\mathrm{T}_{\mathrm{r}}$ | Rise Time |  |  |  | 40 |  |  |
| $\mathrm{T}_{\mathrm{d} \text { (off) }}$ | Turn-off Delay Time |  |  |  | 650 |  |  |
| $\mathrm{T}_{\mathrm{f}}$ | Fall Time |  |  |  | 180 |  |  |
| $\mathrm{T}_{\mathrm{d}(\text { (on) }}$ | Turn-on Delay Time | $\begin{aligned} & \hline \text { Inductive Switching }\left(125^{\circ} \mathrm{C}\right) \\ & \mathrm{V}_{\mathrm{GE}}=15 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{Bus}}=900 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{C}}=225 \mathrm{~A} \\ & \mathrm{R}_{\mathrm{G}}=3.3 \Omega \\ & \hline \end{aligned}$ |  |  | 400 |  | ns |
| $\mathrm{T}_{\mathrm{r}}$ | Rise Time |  |  |  | 50 |  |  |
| $\mathrm{T}_{\mathrm{d} \text { (off) }}$ | Turn-off Delay Time |  |  |  | 800 |  |  |
| $\mathrm{T}_{\mathrm{f}}$ | Fall Time |  |  |  | 300 |  |  |
| $\mathrm{E}_{\text {on }}$ | Turn-on Switching Energy | $\begin{aligned} & \mathrm{V}_{\mathrm{GE}}=15 \mathrm{~V} \\ & \mathrm{~V}_{\text {Bus }}=900 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{C}}=225 \mathrm{~A} \\ & \mathrm{R}_{\mathrm{G}}=3.3 \Omega \end{aligned}$ | $\mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C}$ |  | 72 |  | mJ |
| $\mathrm{E}_{\text {off }}$ | Turn-off Switching Energy |  | $\mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C}$ |  | 70.5 |  |  |

## Reverse diode ratings and characteristics

| Symbol | Characteristic | Test Conditions |  | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {RRM }}$ | Maximum Peak Repetitive Reverse Voltage |  |  | 1700 |  |  | V |
| $\mathrm{I}_{\mathrm{RM}}$ | Maximum Reverse Leakage Current | $\mathrm{V}_{\mathrm{R}}=1700 \mathrm{~V}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  |  | 500 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C}$ |  |  | 750 |  |
| $\mathrm{I}_{\mathrm{F}}$ | DC Forward Current |  | $\mathrm{Tc}=80^{\circ} \mathrm{C}$ |  | 225 |  | A |
| $\mathrm{V}_{\mathrm{F}}$ | Diode Forward Voltage | $\mathrm{I}_{\mathrm{F}}=225 \mathrm{~A}$ | $\mathrm{T}_{\mathrm{i}}=25^{\circ} \mathrm{C}$ |  | 1.8 | 2.2 | V |
|  |  |  | $\mathrm{T}_{\mathrm{i}}=125^{\circ} \mathrm{C}$ |  | 1.9 |  |  |
| $\mathrm{t}_{\mathrm{rr}}$ | Reverse Recovery Time | $\begin{aligned} & \mathrm{I}_{\mathrm{F}}=225 \mathrm{~A} \\ & \mathrm{~V}_{\mathrm{R}}=900 \mathrm{~V} \\ & \mathrm{di} / \mathrm{dt}=2400 \mathrm{~A} / \mu \mathrm{s} \end{aligned}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  | 385 |  | ns |
|  |  |  | $\mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C}$ |  | 490 |  |  |
| $\mathrm{Q}_{\mathrm{rr}}$ | Reverse Recovery Charge |  | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  | 57 |  | $\mu \mathrm{C}$ |
|  |  |  | $\mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C}$ |  | 93 |  |  |
| $\mathrm{E}_{\mathrm{r}}$ | Reverse Recovery Energy |  | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  | 26 |  | mJ |
|  |  |  | $\mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C}$ |  | 52 |  |  |

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Thermal and package characteristics


SP6 Package outline (dimensions in mm)


See application note APT0601 - Mounting Instructions for SP6 Power Modules on www.microsemi.com

## Typical Performance Curve






Reverse Bias Safe Operating Area


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